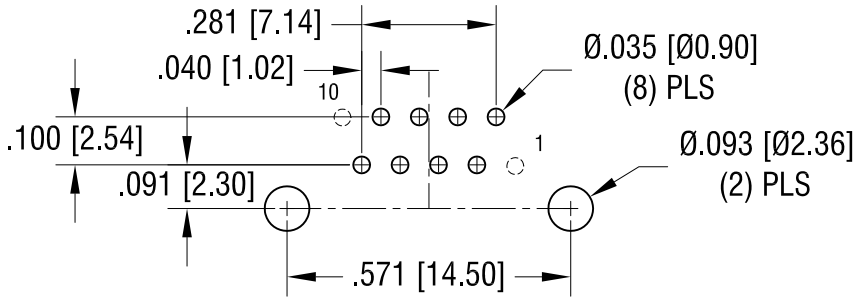
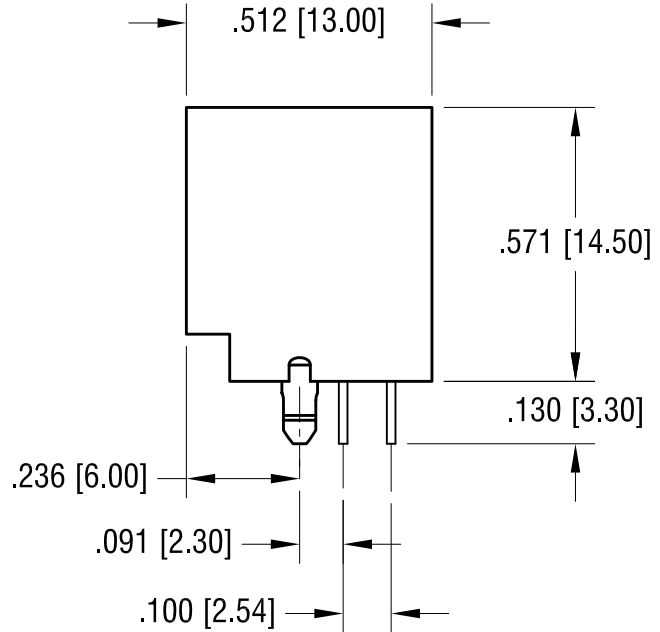
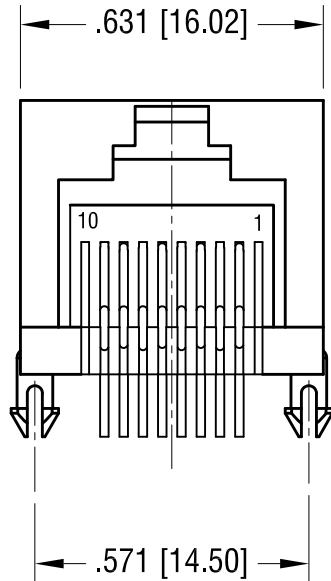
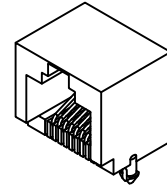


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PCB LAYOUT



ACTUAL SIZE



NOTE:

1. PLASTIC HOUSING:
MAT'L- GLASS FILLED POLYESTER
RATED UL 94V-0, COLOR- BLACK
2. CONTACT: MAT'L PHOSPHOR BRONZE Ø0.18 [0.46]
FINISH- GOLD PLATE, OVER NICKEL ON CONTACT
TIN, OVER COPPER ON SOLDER TAILS
3. DIELECTRIC WITHSTANDING VOLTAGE:
1000 VAC FOR 1 MIN.
4. STORAGE TEMPERATURE:
-40°F (-40°C) TO +176°F (+85°C)
OPERATION TEMPERATURE:
-4°F (-20°C) TO 167°F (+75°C)
5. VOLTAGE RATING: 125 VAC Rms.
CURRENT RATING- 1.5 Amps
CONTACT RESISTANCE- 30 mΩ MAX.
INSULATION RESISTANCE- 500 MΩ MIN. @500 VDC
DIELECTRIC STRENGTH: 1000 Vac Rms 60Hz. 1Min.

KEYSTONE ELECTRONICS CORP.

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PART NAME			
MODULAR KEYSTONE JACK, 8P8C			
MATERIAL			
AS NOTED			
FINISH		DRN BY	DATE
AS NOTED		NT	4.09.15
		APP'D	SCALE
		RH	2.5X
TOLERANCES	INCH [MM]	CODE	DWG NO.
DECIMAL	± .005 [± 0.13]	C	942
ANGULAR	± 1°		
UNLESS OTHERWISE SPECIFIED			

2.08.21	UPDATED PER NEW TOOLING CHANGE AS PER ECN 21-014	B
7.27.15	PCB LAYOUT WAS MIRRORED CHANGE AS PER ECN 15-071	A
DATE	DESCRIPTION	REV.